

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company	 STMicroelectronics International N.V
1.2 PCN No.	ANALOG MEMS SENSORS/25/15577
1.3 Title of PCN	ST Manufacturing Reshaping (Analog_Adv BCD9 GALvanic_AG200toSG8_All): Qualification of SG8 (Singapore) as new FE Location.
1.4 Product Category	Please refer to Products List in BCD9 GALvanic.
1.5 Issue date	2025-07-24

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Domenico ARRIGO
2.2.2 Marketing Manager	Fabio CHELLI
2.2.3 Quality Manager	Alessandro PLATINI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Manufacturing reshaping program	Manufacturing reshaping program	SG8 (Singapore) as Front End Plant.

4. Description of change

	Old	New
4.1 Description	AG200 (Italy) as Front End Plant.	SG8 (Singapore) as Front End Plant.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact. The products guarantee the same quality and electrical characteristics as per current production.	

5. Reason / motivation for change

5.1 Motivation	In the frame of ST manufacturing reshaping program (refer to Corporate PCI 15383 - Early Notification), following the continuous improvement of our service and to increase production Capacity, ST Microelectronics is announcing the qualification of SG8 (Singapore) as FE Location for the impacted Products in BCD9 GALvanic Technology. Please be advised that the enclosed list of products and dates could be subject to change. Such modifications may occur as part of the ongoing transformation program and will be communicated as and when available. ST will explore the scale up of this technology perimeter and products into 300mm (12") in the future in AG factory. Any timeline and specific communication would be done in future with customers.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	Traceability of change will be ensured by an internal codification (Finished Good/Type) printed on the carton box label.
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7. Timing / schedule

7.1 Date of qualification results	2027-03-15
7.2 Intended start of delivery	2027-08-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	
8.2 Qualification report and qualification results	In progress

9. Attachments (additional documentations)

15577 Public product.pdf
15577 Qualification Plan Detail_advBCD9 Galv.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STGAP3S6ITR	
	STGAP3S6STR	
	STGAP3SXITR	
	STGAP3SXSTR	

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